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## **Distance linear image sensor**

S12973-01CT

# Measures the distance to an object by TOF (time-of-flight) method

The distance image sensor is designed to measure the distance to an object by TOF method. When used in combination with a pulse modulated light source, this sensor outputs phase difference information on the timing that the light is emitted and received. The sensor signals are arithmetically processed by an external signal processing circuit or a PC to obtain distance data. We provide an evaluation kit for this product. Contact us for detailed information.

#### 🕨 Features

- High-speed charge transfer
- ➡ Wide dynamic range, low noise by non-destructive readout
- Operates with minimal detection errors even under fluctuating background light (charge drain function)
- Number of effective pixels: 64
- Real-time distance measurement

#### Applications

- Obstacle detection (self-driving, robots, etc.)
- Security (intrusion detection, etc.)
- Shape recognition (logistics, robots, etc.)
- Motion capture

#### Structure

Parameter	Specification	Unit
Image size	$1.408 \times 0.05$	mm
Pixel pitch	22	μm
Pixel height	50	μm
Number of pixels	80	pixels
Number of effective pixels	64	pixels
Package	22-pin PWB	-
Window material	AR-coated glass	-

Note: This product is not hermetically sealed.

#### Absolute maximum ratings

P	arameter	Symbol	Condition	Value	Unit
Analog supply voltage	log supply voltage		Ta=25 °C	-0.3 to +6	V
Digital supply voltage		Vdd(D)	Ta=25 °C	-0.3 to +6	V
	Pixel amplifier	Vsf			
Analog input terminal voltage	Pixel reset	Vr	Ta=25 °C	-0.3 to Vdd(A) + 0.3	V
voltage	Photosensitive area	Vpg			
	Pixel reset pulse	pix_reset			
Disital insult to united	Signal sampling pulse	phis			
Digital input terminal voltage	Master clock pulse	mclk	Ta=25 °C	-0.3 to Vdd(D) + 0.3	V
voltage	Signal readout trigger pulse	trig			
	Output signal synchronous pulse	dclk			
Charge transfer clock p	ulse voltage	VTX1, VTX2, VTX3	Ta=25 °C	-0.3 to Vdd(A) + 0.3	V
Operating temperature		Topr	No dew condensation <sup>*1</sup>	-25 to +85	°C
Storage temperature		Tstg	No dew condensation <sup>*1</sup>	-40 to +100	°C
Soldering temperature*	2	Tsol		260 (twice)	°C
** `**					

\*1: When there is a temperature difference between a product and the surrounding area in high humidity environment, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.
\*2: Reflow soldering, IPC/JEDEC J-STD-020 MSL 3, see P.10

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

1

#### Recommended terminal voltage (Ta=25 °C)

Parameter		Symbol	Min.	Тур.	Max.	Unit	
Analog supply voltage		Vdd(A)	4.75	5	5.25	V	
Digital supply voltage		Vdd(D)	4.75	5	5.25	V	
	Pixel amplifier	Vsf	4.5	5	Vdd(A)	V	
Bias voltage	Pixel reset	Vr	4	4.25	Vdd(A)	V	
bias voitage	Photosensitive area	Vpg	0.8	1.0	1.2	V	
Pixel reset pulse voltage	High level	pix_reset	3.15	-	-	V	
	Low level		-	-	Vdd(D) × 0.2		
	High level	phis	3.15	-	-	V	
Signal sampling pulse voltage	Low level		-	-	Vdd(D) × 0.2		
Master deals pulse valtage	High level	mall	3.15	-	-	V	
Master clock pulse voltage	Low level	mclk	-	-	Vdd(D) × 0.2	V	
Signal readout trigger pulse	High level	tria	3.15	-	-	V	
voltage	Low level	trig	-	-	Vdd(D) × 0.2	V	
Output signal synchronous pulse	High level	dclk	Vdd(D) × 0.8	-	-	V	
voltage	Low level	UCIK	-	-	Vdd(D) × 0.2	V	

#### Electrical characteristics [Ta=25 °C, Vdd(A)=Vdd(D)=5 V]

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Clock pulse frequency	f(mclk)		1 M	-	5 M	Hz
Video data rate	VR		-	f(mclk)	-	Hz
Current consumption	Icc	Dark state	-	8	16	mA

#### Electrical and optical characteristics [Ta=25 °C, Vdd(A)=Vdd(D)=5 V, Vsf=5 V, Vr=4.25 V, MCLK=5 MHz]

Parameter	Symbol	Min.	Тур.	Max.	Unit		
Spectral response range	λ		440 to 1000				
Peak sensitivity wavelength	λр	-	800	-	nm		
Photosensitivity*3	S	$1.5 \times 10^{12}$	$2.2 \times 10^{12}$	$2.6 \times 10^{12}$	V/(W·s)		
Dark output	Vd	-	0.5	10	V/s		
Random noise	RN	-	0.4	0.8	mV rms		
Dark output voltage*4	Vor	3.1	3.4	3.7	V		
Saturation output voltage	Vsat	-	-	1.5	V		
Sensitivity ratio*5	SR	0.9	-	1.25	-		
Photoresponse nonuniformity*6	PRNU	-	-	±10	%		

\*3: Monochromatic wavelength light source ( $\lambda$ =805 nm)

\*4: Output value right after reset in dark state

\*5: Output ratio of Vout1 (VTX1=3 V, VTX2=VTX3=0 V) to Vout2 (VTX2=3 V, VTX1=VTX3=0 V)

\*6: Photoresponse nonuniformity (PRNU) is the output nonuniformity that occurs when the entire photosensitive area is uniformly illuminated by light which is 50% of the saturation exposure level. PRNU is measured using 64 pixels excluding 8 pixels each at both ends, and is defined as follow:

 $PRNU=\Delta X/X \times 100 (\%)$ 

X: average of the output of all pixels,  $\Delta X$ : difference between the maximum or minimum output and X





#### Spectral response (typical example)

KMPDB0375EB

#### Block diagram



#### Basic connection example









4

#### - Calculation method of frame rate

Frame rate=1/(Time per frame)

=1/(Integration time + Readout time)

It is necessary to be changed by the required distance accuracy and usage environment factors such as fl uctuating background light.

Readout time=  $\frac{1}{\text{Clock pulse frequency}} \times \text{Number of horizontal pixels}$ 

=Time per clock (Readout time per pixel) × Number of horizontal pixels

Calculation example of readout time (clock pulse frequency=5 MHz, number of horizontal pixels=80)

Readout time=  $\frac{1}{5 \times 10^6 \text{ [Hz]}} \times 80$ =200 [ns] × 80 =0.016 [ms]

When operating in non-destructive readout mode:

Time per frame=Integration time + (Readout time × Non-destructive readout count)



Parameter	Symbol	Min.	Тур.	Max.	Unit
Master clock pulse duty ratio	-	45	50	55	%
Master clock pulse rise and fall times	tr(mclk), tf(mclk)	0	-	20	ns
Pixel reset pulse high period	thp(pix_reset)	10	-	-	μs
Pixel reset pulse rise and fall times	tr(pix_reset), tf(pix_reset)	0	-	20	ns
Signal sampling pulse high period	thp(phic)	1	-	-	μs
Signal sampling pulse rise and fall times	tr(phic), tf(phic)	0	-	20	ns
Signal readout trigger pulse rise and fall times	tr(trig), tf(trig)	0	-	20	ns
Time from rising edge of master clock pulse to pixel reset pulse	tO	0	-	-	ns
Time from falling edge of pixel reset pulse to rising edge of signal sampling pulse	t1	1	-	-	μs
Time from falling edge of signal sampling pulse to ris- ing edge of signal readout trigger pulse	t2	1.2	-	-	μs
Time from rising edge of master clock pulse to rising edge of signal readout trigger pulse	t3	$1/4 \times 1/$ f(mclk)	-	$1/2 \times 1/$ f(mclk)	S
Time from rising edge of signal readout trigger pulse to rising edge of master clock pulse	t4	$1/4 \times 1/$ f(mclk)	-	$1/2 \times 1/$ f(mclk)	S
Time from rising edge of master clock pulse to falling edge of signal readout trigger pulse	t5	$1/4 \times 1/$ f(mclk)	-	$1/2 \times 1/$ f(mclk)	S
Time from falling edge of signal readout trigger pulse to rising edge of master clock pulse	t6	$1/4 \times 1/$ f(mclk)	-	$1/2 \times 1/$ f(mclk)	S
Time from rising edge of master clock pulse (after reading signals from all pixels) to rising edge of output signal sampling pulse	t7	1/f(mclk)	-	-	S
Time from rising edge of master clock pulse (after reading signals from all pixels) to rising edge of pixel reset pulse	t8	1/f(mclk)	-	-	S
Time from rising edge of master clock pulse to falling edge of output signal synchronous pulse*7	td(dclk)	0	25	50	ns
Output signal synchronous pulse output voltage rise time (10 to 90%)*7	tr(dclk)	-	20	40	ns
Output signal synchronous pulse output voltage fall time (10 to 90%)*7	tf(dclk)	-	20	40	ns
Settling time of output signal 1, 2 (10 to 90%)*7 *8	tr(Vout), tf(Vout)	-	35	70	ns
Time from rising edge of master clock pulse to output signal 1, 2 (output 50%) <sup><math>*7</math></sup>	td(Vout)	-	40	80	ns
Charge transfer clock pulse interval	tpi(VTX)	60	-	-	ns
Charge transfer clock pulse (VTX1) high period	thp(VTX1)	30	-	-	ns
Charge transfer clock pulse (VTX1) low period	tlp(VTX1)	-	tpi(VTX) - thp(VTX2) - thp(VTX3)	-	ns
Charge transfer clock pulse (VTX2) high period	thp(VTX2)	30	-	-	ns
Charge transfer clock pulse (VTX2) low period	tlp(VTX2)	-	tpi(VTX) - thp(VTX1) - thp(VTX3)	-	ns
Charge transfer clock pulse (VTX3) high period	thp(VTX3)	0	-	-	ns
Charge transfer clock pulse (VTX3) low period	tlp(VTX3)	-	tpi(VTX) - thp(VTX1) - thp(VTX2)	-	ns
Charge transfer clock pulse voltage rise time	tr(VTX)	-	3	-	ns
Charge transfer clock pulse voltage fall time	tf(VTX)	-	3	-	ns
Charge transfer clock High level	VTX1, VTX2, VTX3	-	3.3	-	V
pulse voltage Low level		_	0	-	V
Time from the falling edge of the signal readout trigger pulse to the start of VTX operation	t9	1/f(mclk)	-	-	S
Time from the end of VTX operation to the rising edge of the output signal synchronous pulse	t10	1/f(mclk)	-	-	S
Time from the end of VTX operation to the rising edge of the pixel reset pulse	t11	1/f(mclk)	-	-	S

\*7: Load capacitance CL=3 pF \*8: Output voltage=0.1 V



#### Input terminal capacitance (Ta=25 °C, Vdd=5 V)

Parameter	Symbol	Min.	Тур.	Max.	Unit
Charge transfer clock pulse internal load capacitance	Cltx	-	25	-	pF

#### Dimensional outline (unit: mm)

### Recommended land pattern (unit: mm)



KMPDA0570ED



#### Pin connections

Pin no.	Symbol	I/O	Description		
1	Vr	Ι	Bias voltage (pixel reset)		
2	VTX3	Ι	Charge transfer clock pulse 3		
3	VTX2	Ι	Charge transfer clock pulse 2		
4	VTX1	Ι	Charge transfer clock pulse 1		
5	pix_reset	Ι	Pixel reset pulse		
6	phis	Ι	Signal sampling pulse		
7	mclk	Ι	Master clock pulse		
8	trig	Ι	Signal readout trigger pulse		
9	dclk	0	Output signal synchronous pulse		
10	Vdd(D)	Ι	Digital supply voltage		
11	GND	Ι	Ground		
12	Vout2	0	Output signal 2		
13	Vout1	0	Output signal 1		
14	GND	Ι	Ground		
15	Vdd(A)	Ι	Analog supply voltage		
16	Vpg	Ι	Bias voltage (photosensitive area)		
17	Vsf	Ι	Bias voltage (pixel amplifier)		
18	GND	Ι	Ground		
19	GND	Ι	Ground		
20	GND	Ι	Ground		
21	GND	Ι	Ground		
22	GND	Ι	Ground		

Note: Connect an impedance converting buffer amplifier to Vout1/Vout2 terminals so as to minimize the current flow.



#### Reel packing specifications

■ Reel (conforms to JEITA ET-7200)

Outer diameter	Hub diameter	Tape width	Material	Electrostatic characteristics
φ330 mm	φ100 mm	24 mm	PS	Conductive

Embossed tape (unit: mm, material: PS, conductive)



Packing quantity 2000 pcs/reel

Packing state

Reel and desiccant in moisture-proof packaging (vacuum-sealed)



#### Recommended soldering conditions



Time

KMPDB0381EA

- This product supports lead-free soldering. After unpacking, store it in an environment at a temperature of 30 °C or less and a humidity of 60% or less, and perform soldering within 168 hours.
- The effect that the product receives during reflow soldering varies depending on the circuit board and reflow oven that are used. When you set reflow soldering conditions, check that problems do not occur in the product by testing out the conditions in advance.

#### Related information

www.hamamatsu.com/sp/ssd/doc\_en.html

- Precautions
- $\cdot$  Disclaimer
- $\cdot$  Surface mount type products
- Technical information
- · Distance image sensors (Front-illuminated type)



#### Evaluation kit for distance linear image sensor C14319-05

An evaluation kit [110 mm (H) × 70 mm (V)] is available for the S12973-01CT distance linear image sensor (with the S12973-01CT). Contact us for detailed information.



Information described in this material is current as of November 2021.

Product specifications are subject to change without prior notice due to improvements or other reasons. This document has been carefully prepared and the information contained is believed to be accurate. In rare cases, however, there may be inaccuracies such as text errors. Before using these products, always contact us for the delivery specification sheet to check the latest specifications.

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